Docket No.

213480US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Sei TSUNODA, et al.

SERIAL NO: 09/942,626

GAU:

1751

FILED:

August 31, 2001

EXAMINER: HAMLIN, D.G.

FOR:

LOW DIELECTRIC CONSTANT MATERIAL HAVING THERMAL RESISTANCE, INSULATION FILM BETWEEN SEMICONDUCTOR LAYERS USING THE SAME, AND SEMICONDUCTOR

DEVICE

REQUEST FOR EXTENSION OF TIME UNDER 37 C.F.R. 1.136

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

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It is	s hereby requested that a two month extension of time be granted to April 19, 2005 for
	filing a response to the Official Action dated:
	responding to the requirements in the Notice of Allowability dated:
	filing the Formal Drawings. The Issue Fee due has been timely filed.
	responding to the Notice to File Missing Parts of Application dated:
	filing a Notice of Appeal, attached herewith.
	filing an Appeal Brief. A Notice of Appeal was filed on:
	Applicant claims small entity status. See 37 CFR 1.27. Therefore, the fee amount shown below is reduced by one-half.
	e required fee of \$450.00 is enclosed herewith by credit card payment and any further charges may be made against Attorney of Record's Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully Submitted,

04/20/2005 JADD01 00000022 09942626

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OBLON, SPIVAK, McCLELLAND,

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